

Jacob, Rebecca (ASRC)

464394

From: STIC-ILL /  
Sent: Tuesday, September 16, 2003 12:19 PM  
To: Jacob, Rebecca (ASRC)  
Subject: FW: ILL order

464555

-----Original Message-----

From: Bates, Darcy  
Sent: Tuesday, September 16, 2003 12:09 PM  
To: STIC-ILL  
Cc: Harrison, Jeff; Speckhard, Irina (ASRC); Fagbohunka, Bode (ASRC)  
Subject: ILL order

Hi,

We do not have the following item in STIC. Please order this item for Tuan Nguyen, CP4-4D17.

ILL Ordering Information

Date Needed<9-18-03>

Art Unit or Location <2813>

Telephone Number <308-2550>

AN 1993:4417102 INSPEC DN B9307-2570D-011

Title: **Selective electroless Ni deposition onto Pd-activated Si for integrated circuit fabrication.**

Author(s): Dubin, V.M.; Lopatin, S.D.; Sokolov, V.G. (Byelorussian State Univ., Minsk, Byelorussia)

Source: **Thin Solid Films (15 April 1993) vol.226, no.1, p.94-8. 14 refs.**

Price: CCCC 0040-6090/93/\$6.00

CODEN: THSFAP ISSN: 0040-6090

DT Journal

TC Experimental

CY Switzerland

LA English

Thank you,

*Darcy Bates*

EIC 2800 Technical Information Specialist

U.S. Patent & Trademark Office

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COMPLETED